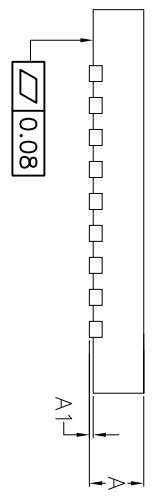
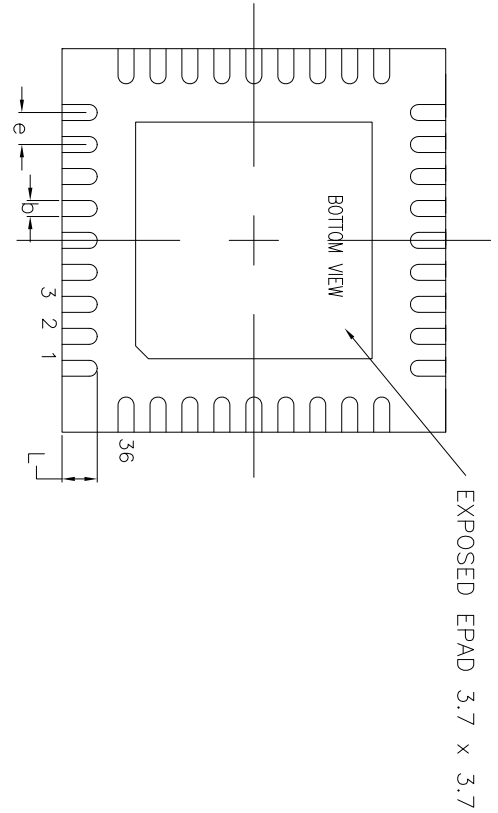
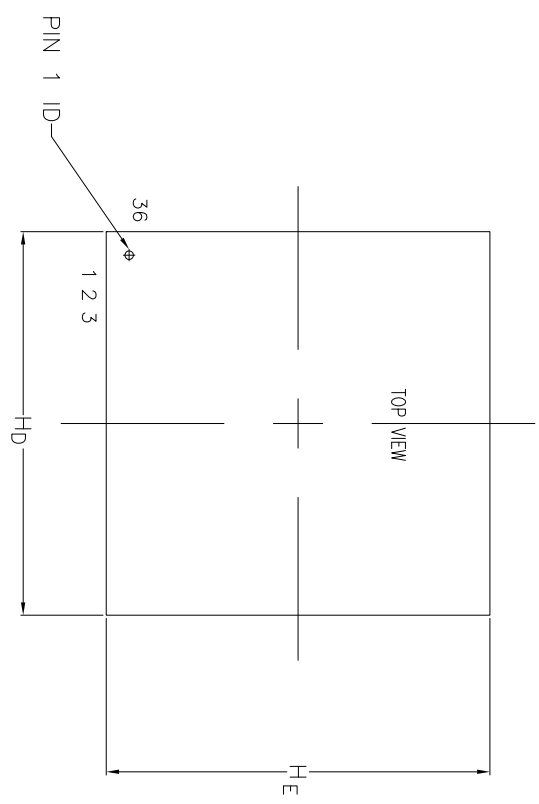


REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	2/23/16	JHUJA

BASED ON JEDEC MO-220
 1. DIMENSIONS (IN MILLIMETERS)



- WEIGHT <math>< 0.1\text{ g}</math>
- PACKAGE BODY MATERIAL LOW STRESS EPOXY
- LEAD MATERIAL Cu-ALLOY
- LEAD FINISH SOLDER PLATING

DIMENSIONS	min	max
A	0.8	0.9
A1	0	0.05
b	0.2	0.3
e	0.5	nom
Hd	5.9	6.1
HE	5.9	6.1
L	0.45	0.65

TOLERANCES UNLESS SPECIFIED		DATE	
DECIMAL	ANGULAR	12/23/16	
XXX±	±		
XXXX			
XXXXX			
 IDT ™ 6024 Silver Creek Valley Rd San Jose, CA 95138 PHONE: (408) 727-6116 FAX: (408) 492-8674		TITLE NLG36 PACKAGE OUTLINE 6.0 x 6.0 mm BODY , EPAD 3.7 x 3.7 0.50 mm PITCH QFN	
APPROVALS	DATE	SIZE	DRAWING No.
DRAWN: DAC	12/23/16	C	PSC-4648-01
CHECKED			
DO NOT SCALE DRAWING			REV 00
			SHEET 1 OF 1